LAW OFFICES OF RONALD M. ANDERSON 600 - 108th Avenue N.E., Suite 507 Bellevue, Washington 98004 Telephone: (425) 688-8816 Fax: (425) 646-6314

1	6. Pursuant to 37 C.F.R. § 1.97(d), this information disclosure statement is being filed after the mailing date of either:		
2	a a final action under 37 C.F.R. § 1.113; or		
3			
4			
5	but before payment of the issue fee. The statement is accompanied by a certification as specified in 37 C.F.R. § 1.97(e), a petition requesting		
6	consideration of the information disclosure statement, and the petition fee set forth in 37 C.F.R. § 1.17(i)(1). Check No		
7	\$ is enclosed.		
8	X 7. Please charge any additional fees or credit any overpayment to Deposit Account No. 01-1940. A copy of this sheet is enclosed.		
9	Respectfully submitted,		
10			
11 12	Ron anderson		
	Ronald M. Anderson		
13	Registration No. 28,829		
14	envelope as first class mail with postage thereon fully prepaid addressed to Director of the District in a sealed		
15			
16	Date: December 4, 2002		
17			
18			
19			
20			
21			
22			
23			
24			
25			
6			
11			

# SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT LISTING SHEET

## Information Cited By Applicant(s) That May Be Material To The Prosecution Of The Subject Application

Golbig et al.

Attorney Docket No. CELL0018

Serial No .:

09/991,377

Group Art Unit: 1743

Filed:

November 15, 2001

Examiner:

Title:

DEC 1 2 2002 ENHANCING FLUID FLOW IN A STACKED PLATE MICROREACTOR

#### **U.S. PATENT DOCUMENTS**

\*Examiner <u>Initial</u>

 ${
m I\!D}$ 

Document No.

Date

<u>Name</u>

Class

Sub-Class

US<sub>1</sub>

US2002/0080563

06/27/2001

Pence et al.

361

676

## FOREIGN PATENT DOCUMENTS

**NONE CITED** 

### **OTHER INFORMATION**

**NONE CITED** 

Examiner's Signature	Date
Chailmiel & Signature	Date

RMA:MCK:ssa 12/4/02

<sup>\*</sup>Examiner: Initial if reference considered, whether or not citation is in conformance with M.P.E.P. § 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.